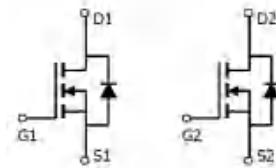
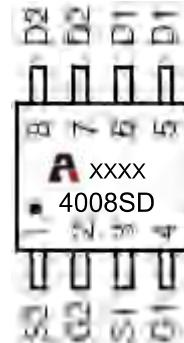


Feature

- 40V,10A
- $R_{DS(on)} < 22m\Omega$ @ $V_{GS}=10V$
- $R_{DS(on)} < 30m\Omega$ @ $V_{GS}=4.5V$
- Trench DMOS Power MOSFET
- Fast Switching
- Exceptional on-resistance and maximum DC current capability



Schematic diagram



Marking and pin assignment

Application

- DC/DC Converter
- Load Switch for Portable Devices
- Battery Switch

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity (PCS)
4008SD	AP4008SD	SOP-8	13 inch	-	4000

ABSOLUTE MAXIMUM RATINGS ($T_a=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	40	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ($T_a = 25^\circ C$)	I_D	10	A
Continuous Drain Current ($T_a = 100^\circ C$)	I_D	6.5	A
Pulsed Drain Current ⁽¹⁾	I_{DM}	40	A
Power Dissipation	P_D	4	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	31.3	$^\circ C/W$
Junction Temperature	T_J	150	$^\circ C$
Storage Temperature	T_{STG}	-55~+150	$^\circ C$

MOSFET ELECTRICAL CHARACTERISTICS($T_a=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	40	-	-	V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 40V, V_{GS} = 0V$	-	-	1	μA
Gate-body leakage current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	± 100	nA
Gate threshold voltage ⁽²⁾	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1	1.6	2.5	V
Drain-source on-resistance ⁽²⁾	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 10A$	-	17	22	$m\Omega$
		$V_{GS} = 4.5V, I_D = 6A$	-	22	30	
Dynamic characteristics						
Input Capacitance	C_{iss}	$V_{DS} = 20V, V_{GS} = 0V, f = 1MHz$	-	1050	-	pF
Output Capacitance	C_{oss}		-	84	-	
Reverse Transfer Capacitance	C_{rss}		-	72	-	
Switching characteristics						
Turn-on delay time	$t_{d(on)}$	$V_{DD}=20V, R_L=1.5\Omega$ $V_{GS}=10V, R_G=3\Omega$	-	11	-	ns
Turn-on rise time	t_r		-	13	-	
Turn-off delay time	$t_{d(off)}$		-	36	-	
Turn-off fall time	t_f		-	9	-	
Total Gate Charge	Q_g	$V_{DS}=20V, I_D=5A,$ $V_{GS}=10V$	-	11	-	nC
Gate-Source Charge	Q_{gs}		-	1.9	-	
Gate-Drain Charge	Q_{gd}		-	2.2	-	
Source-Drain Diode characteristics						
Diode Forward voltage ⁽²⁾	V_{DS}	$V_{GS} = 0V, I_S=10A$	-	-	1.2	V
Diode Forward current ⁽³⁾	I_S		-	-	40	A

Notes:

1. Repetitive Rating: pulse width limited by maximum junction temperature
2. Pulse Test: pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
3. Surface Mounted on FR4 Board, $t \leq 10$ sec

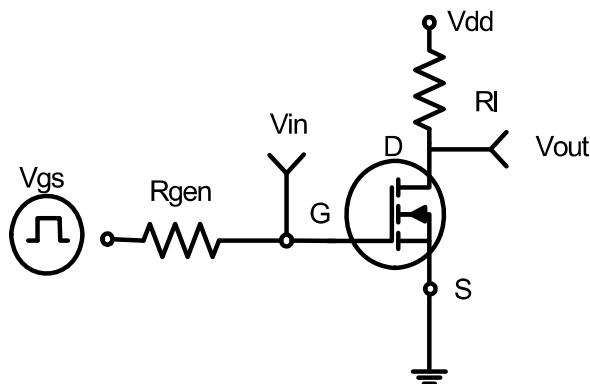


Figure 1:Switching Test Circuit

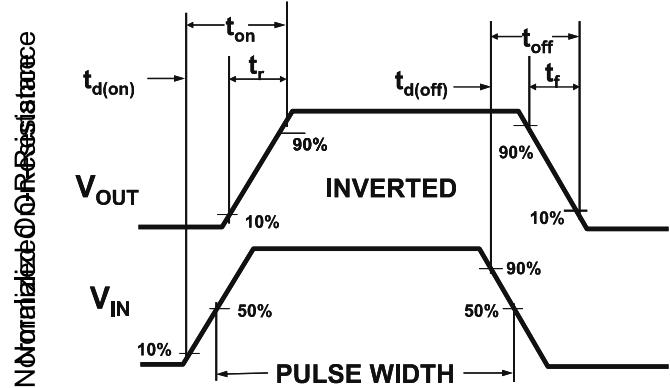


Figure 2:Switching Waveforms

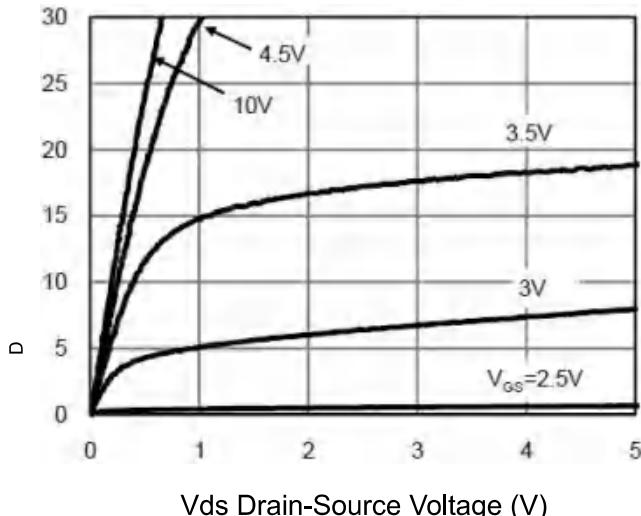


Figure 3 Output Characteristics

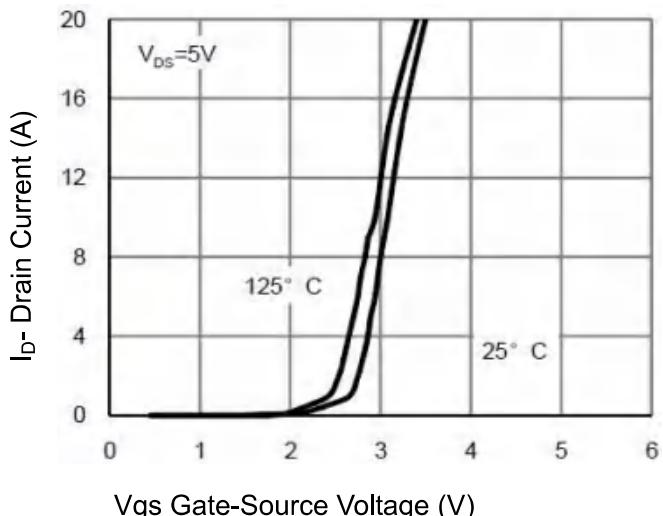


Figure 4 Transfer Characteristics

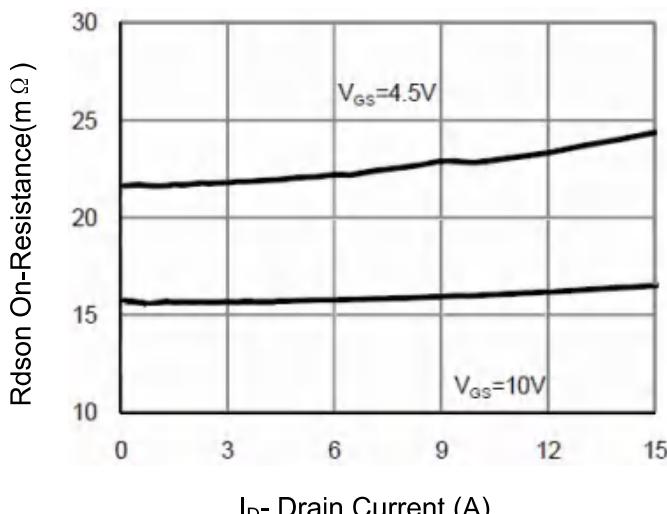


Figure 5 Drain-Source On-Resistance

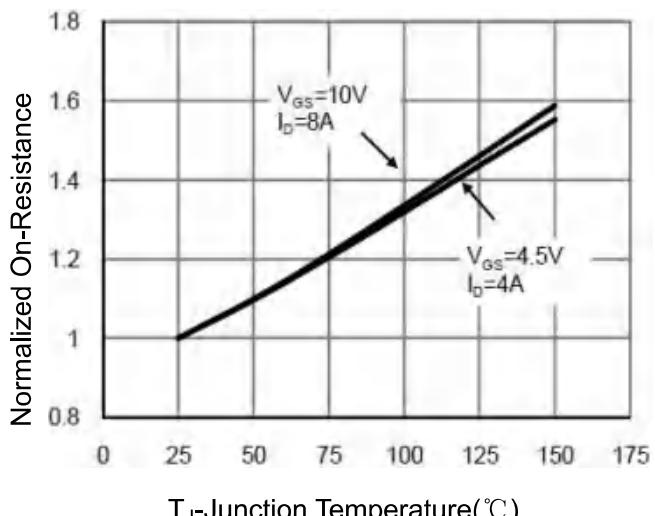


Figure 6 Drain-Source On-Resistance

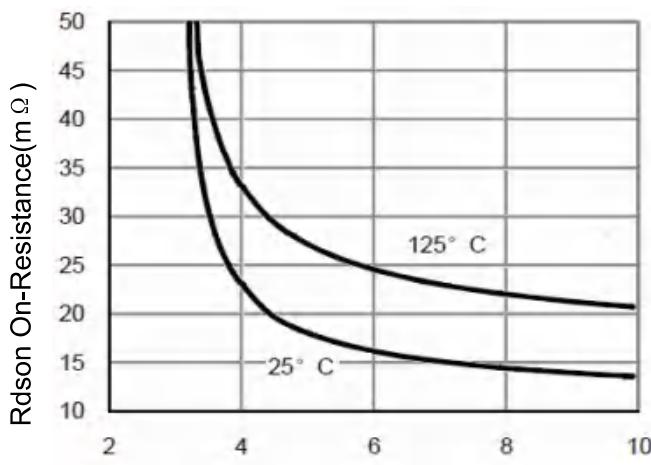


Figure 7 **Rdson vs Vgs**

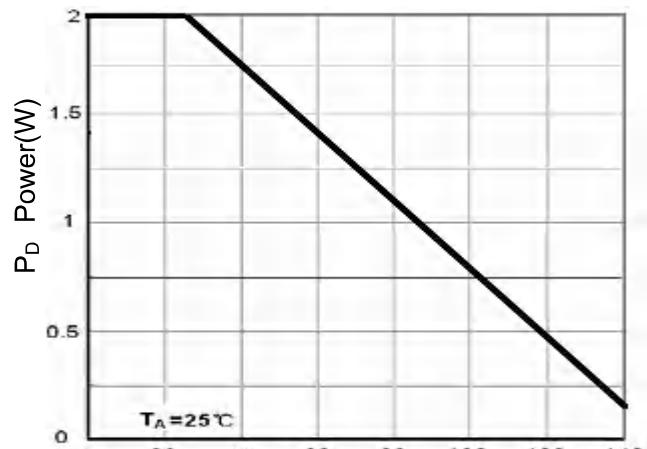


Figure 8 **Power Dissipation**

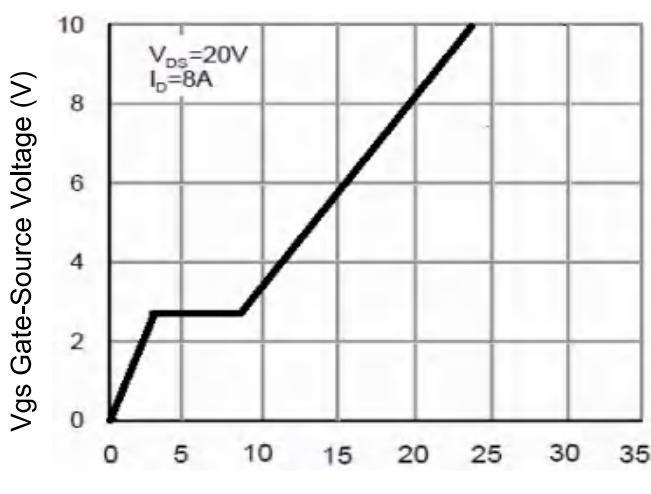


Figure 9 **Gate Charge**

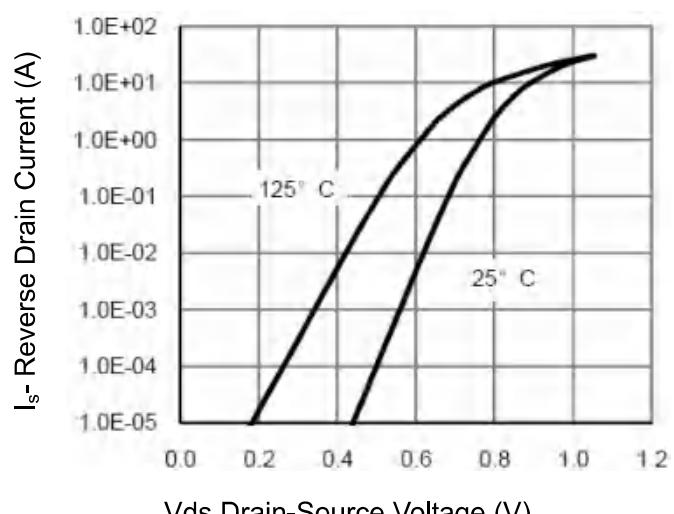


Figure 10 **Source- Drain Diode Forward**

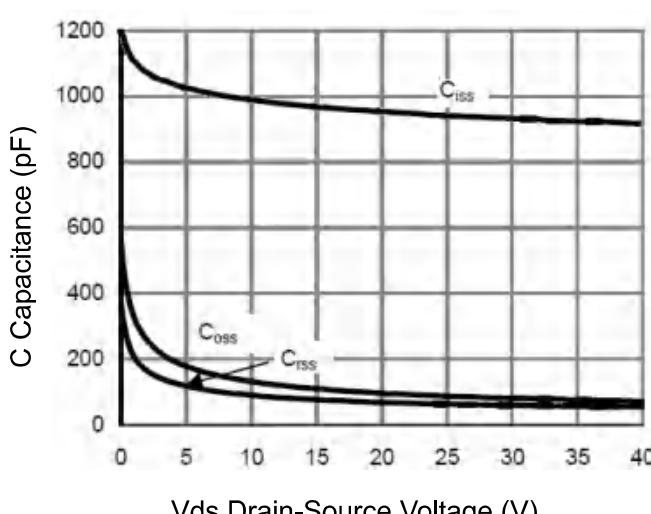


Figure 11 **Capacitance vs Vds**

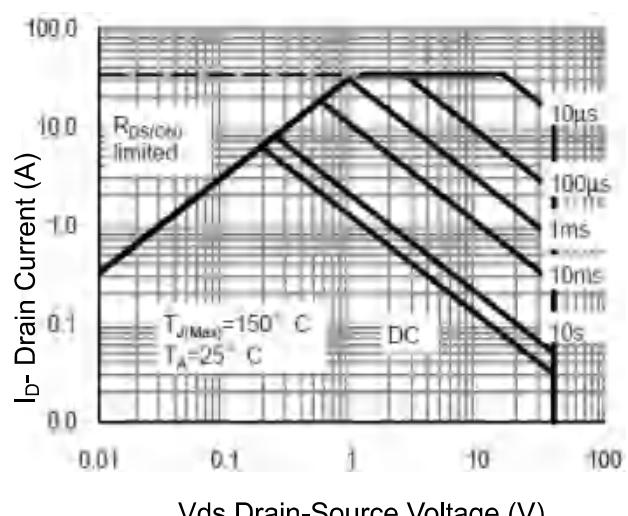
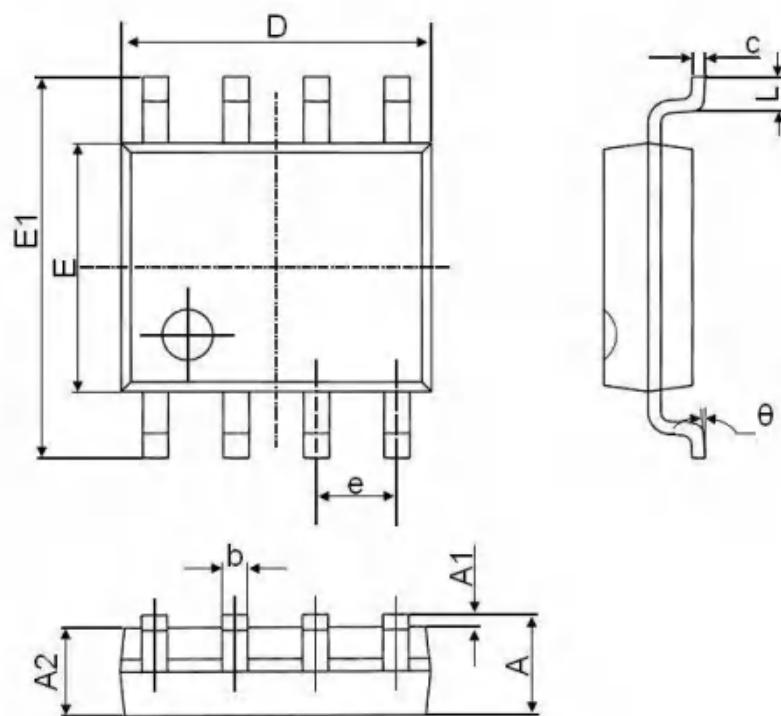


Figure 12 **Safe Operation Area**

SOP-8 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°